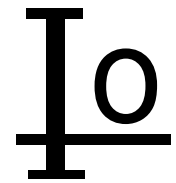


4GBJ10005 THRU 4GBJ1010

GLASS PASSIVATED BRIDGE RECTIFIER Forward Current - 10.0 Amper



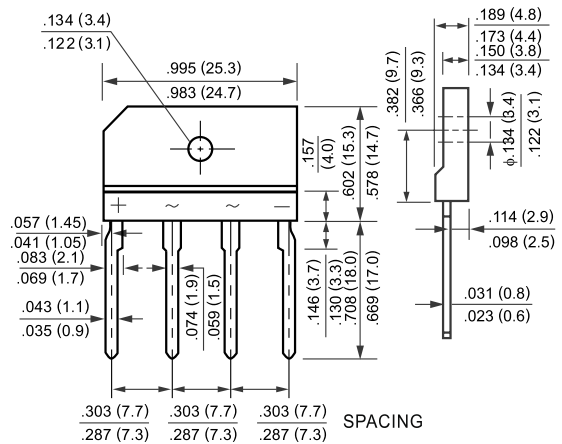
VOLTAGE RANGE

50to1000Volts

CURRENT

10.0Ampere

GBJ4



Dimensions in inches and (millimeters)

FEATURES

- Glass passivated chip junction
- Reliable low cost construction utilizing molded plastic technique
- Ideal for printed circuit board
- Low reverse leakage current
- Low forward voltage drop
- High surge current capability

MECHANICAL DATA

- Case: Molded plastic, GBJ
- Terminals: Terminals: Leads solderable per MIL-STD-202 method 208 guaranteed
- Epoxy: UL 94V-0 rate flame retardant
- Mounting Position: Any
- Lead Free Finish/RoHS Compliant

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	4GBJ 10005	4GBJ 1001	4GBJ 1002	4GBJ 1004	4GBJ 1006	4GBJ 1008	4GBJ 1010	Unit
Peak Repetitive Reverse Voltage	V _{RRM}								
Working Peak Reverse Voltage	V _{RWM}	50	100	200	400	600	800	1000	V
DC Blocking Voltage	V _R								
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @T _C = 115°C (Note 1)	I _O	10							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	220							A
Forward Voltage per diode @I _F = 5.0A	V _{FM}	1.1							V
Peak Reverse Current @T _A = 25°C At Rated DC Blocking Voltage @T _A = 125°C	I _R	10 500							μA
Typical Thermal Resistance per leg (Note 2)	R _{θJA}	26							°C/W
Typical Thermal Resistance per leg (Note 1)	R _{θJC}	1.9							°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-55 to +150							°C

Note: 1. Device mounted on 100 x 100 x 1.6mm thick Al plate heatsink.
2. Device mounted on P.C.B. without heatsink.

RATING AND CHARACTERISTIC CURVES (4GBJ1005 THRU 4GBJ1010)

FIG.1-FORWARD CURRENT DERATING CURVE

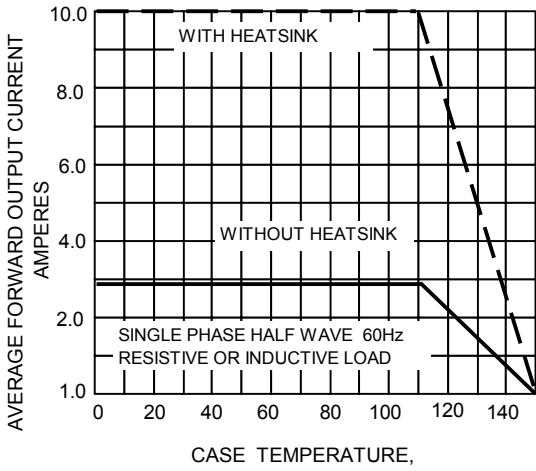


FIG.2-MAXIMUM NON-REPETITIVE SURGE CURRENT

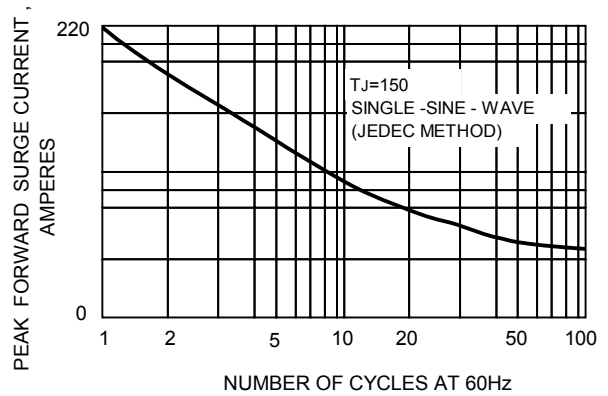


FIG.3-TYPICAL JUNCTION CAPACITANCE

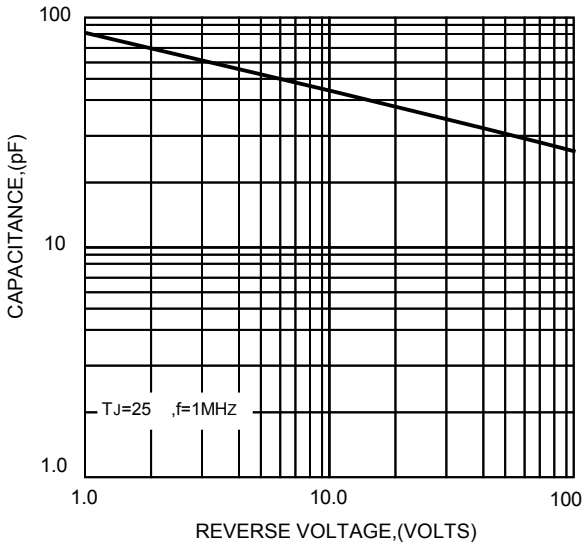


FIG.4-TYPICAL FORWARD CHARACTERISTICS

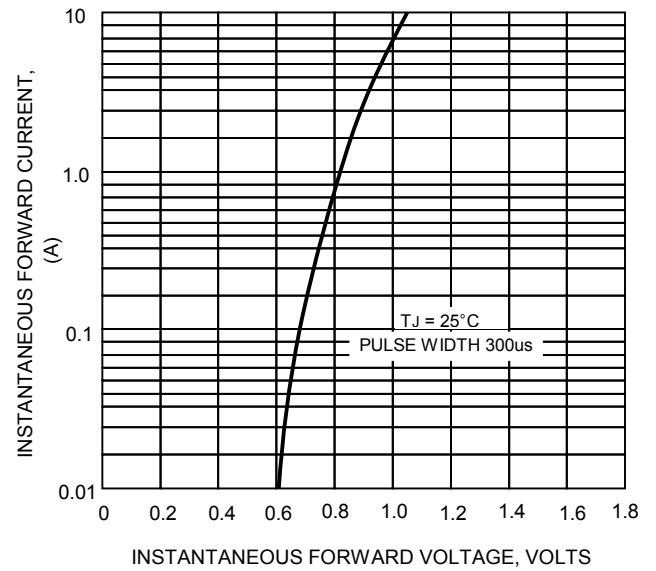


FIG.5-TYPICAL REVERSE CHARACTERISTICS

